



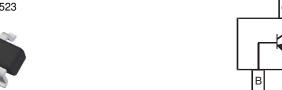
PNP PRE-BIASED SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (MMBT4401T)
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.002 grams (Approximate)



Package Pin Out Configuration

SOT523



Top View

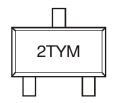
Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
MMBT4403T-7-F	AEC-Q101	2T	7	8	3000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



2T = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2018	2019	2020	2021	202	2 20	23	2024	2025	2026	2027	2028
Code	F	G	Н	- 1	J	I	<	L	М	N	0	Р
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

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Maximum Ratings (@T_A = 25°C, unless otherwise specified.)

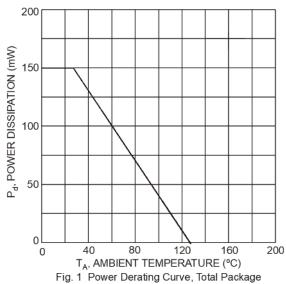
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-5.0	V
Collector Current – Continuous (Note 5)	Ic	-600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	150	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Note: 5. Mounted on FR4 PC Board with minimum recommended pad layout.

Thermal Characteristics and Derating Information





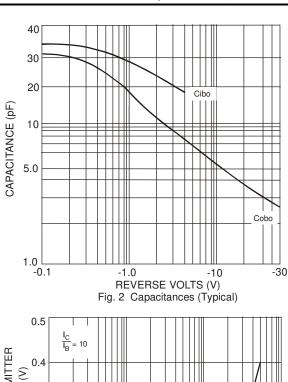
Electrical Characteristics (@TA = 25°C, unless otherwise specified.)

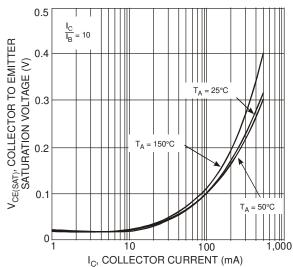
Characteristic	Symbol	Min	Max	Unit	Test Condition			
OFF CHARACTERISTICS (Note 6)								
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	-40	_	V	$I_C = -100 \mu A, I_E = 0$			
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	-40	_	V	$I_C = -1.0 \text{mA}, I_B = 0$			
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	-5.0	_	V	$I_E = -100 \mu A, I_C = 0$			
Collector Cutoff Current	I _{CEX}		-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$			
Base Cutoff Current	I _{BL}	_	-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$			
ON CHARACTERISTICS (Note 6)								
DC Current Gain	h _{FE}	30 60 100 100 20	 300 	-	$\begin{split} & I_{C} = -100 \mu A, \ V_{CE} = -1.0 V \\ & I_{C} = -1.0 m A, \ V_{CE} = -1.0 V \\ & I_{C} = -10 m A, \ V_{CE} = -1.0 V \\ & I_{C} = -150 m A, \ V_{CE} = -2.0 V \\ & I_{C} = -500 m A, \ V_{CE} = -2.0 V \end{split}$			
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		-0.40 -0.75	>	$I_C = -150$ mA, $I_B = -15$ mA $I_C = -500$ mA, $I_B = -50$ mA			
Base-Emitter Saturation Voltage	V _{BE(SAT)}	-0.75 —	-0.95 -1.30	٧	$I_C = -150$ mA, $I_B = -15$ mA $I_C = -500$ mA, $I_B = -50$ mA			
SMALL SIGNAL CHARACTERISTICS								
Output Capacitance	C _{cb}		8.5	pF	$V_{CB} = -10V$, $f = 1.0MHz$, $I_E = 0$			
Input Capacitance	Ceb	_	30	pF	$V_{EB} = -0.5V$, $f = 1.0MHz$, $I_C = 0$			
Input Impedance	h _{ie}	1.5	15	kΩ				
Voltage Feedback Ratio	h _{re}	0.1	8.0	x 10 ⁻⁴	V _{CE} = -10V, I _C = -1.0mA,			
Small Signal Current Gain	h _{fe}	60	500		f = 1.0kHz			
Output Admittance	h _{oe}	1.0	100	μS				
Current Gain-Bandwidth Product	f _T	200	_	MHz	$V_{CE} = -10V$, $I_{C} = -20mA$, $f = 100MHz$			
SWITCHING CHARACTERISTICS								
Delay Time	t _d	_	15	ns	$V_{CC} = -30V, I_{C} = -150mA,$			
Rise Time	t _r	_	20	ns	$V_{BE(off)} = -2.0V, I_{B1} = -15mA$			
Storage Time	ts	_	225	ns	$V_{CC} = -30V, I_{C} = -150mA,$			
Fall Time	t _f	_	30	ns	$I_{B1} = I_{B2} = -15\text{mA}$			

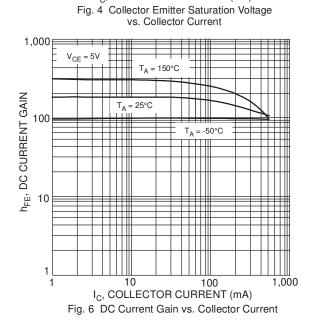
Note: 6. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

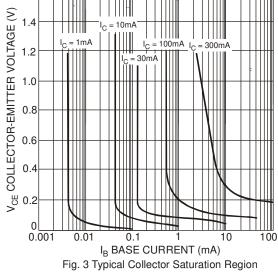


Typical Characteristics (@T_A = +25°C, unless otherwise specified.)









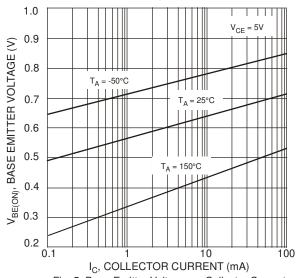


Fig. 5 Base-Emitter Voltage vs. Collector Current

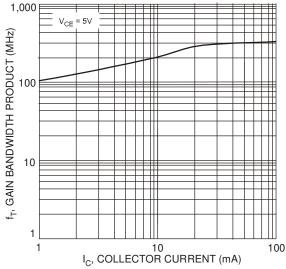


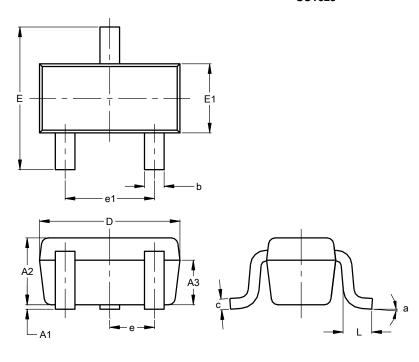
Fig. 7 Gain Bandwidth Product vs. Collector Current



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523

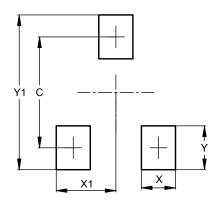


SOT523						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.60	0.80	0.75			
A 3	0.45	0.65	0.50			
b	0.15	0.30	0.22			
С	0.10	0.20	0.12			
D	1.50	1.70	1.60			
Е	1.45	1.75	1.60			
E1	0.75	0.85	0.80			
е	e 0.50 BSC					
e1	0.90	1.10	1.00			
L	0.20	0.40	0.33			
а	0°		8°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523



Dimensions	Value		
С	1.29		
Х	0.40		
X1	0.70		
Υ	0.51		
Y1	1.80		



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